



**CHENMKO ENTERPRISE CO.,LTD**

**SURFACE MOUNT**

**P-Channel Enhancement Mode Field Effect Transistor**

**VOLTAGE 30 Volts CURRENT 15 Ampere**

**CHM5P03PAPT**

*Lead free devices*

#### APPLICATION

- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

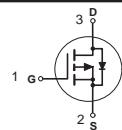
#### FEATURE

- \* Small flat package. ( TO-252A )
- \* High density cell design for extremely low R<sub>DS(ON)</sub>.
- \* Rugged and reliable.

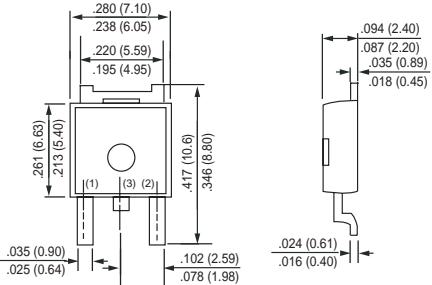
#### CONSTRUCTION

- \* P-Channel Enhancement

#### CIRCUIT



**TO-252A**



1 Gate  
2 Source  
3 Drain (Heat Sink)

Dimensions in inches and (millimeters)

**TO-252A**

#### Absolute Maximum Ratings

T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	CHM5P03PAPT	Units
V <sub>DSS</sub>	Drain-Source Voltage	-30	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous	-15	A
	- Pulsed (Note 3)	-45	
P <sub>D</sub>	Maximum Power Dissipation	42	W
T <sub>J</sub>	Operating Temperature Range	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C

Note : 1. Surface Mounted on FR4 Board , t <=10sec

2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%

3. Repetitive Rating , Pulse width limited by maximum junction temperature

4. Guaranteed by design , not subject to production testing

#### Thermal characteristics

R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1)	50	°C/W
2006-02			

## RATING CHARACTERISTIC CURVES ( CHM5P03PAPT )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -30 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage	$V_{\text{GS}} = 20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
$I_{\text{GSSR}}$	Gate-Body Leakage	$V_{\text{GS}} = -20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

### ON CHARACTERISTICS (Note 2)

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	-1		-3	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = -10 \text{ V}, I_D = -7.5 \text{ A}$		42	70	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5 \text{ V}, I_D = -4.5 \text{ A}$		78	120	
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = -15 \text{ V}, I_D = -7.5 \text{ A}$		8		S

### SWITCHING CHARACTERISTICS (Note 4)

$Q_g$	Total Gate Charge	$V_{\text{DS}} = -15 \text{ V}, I_D = -7.5 \text{ A}$ $V_{\text{GS}} = -10 \text{ V}$		22.5	29	nC
$Q_{\text{gs}}$	Gate-Source Charge			2		
$Q_{\text{gd}}$	Gate-Drain Charge			6		
$t_{\text{on}}$	Turn-On Time	$V_{\text{DD}} = -15 \text{ V}$ $I_D = -1.0 \text{ A}, V_{\text{GS}} = -10 \text{ V}$ $R_{\text{GEN}} = 6 \Omega$		8	15	nS
$t_r$	Rise Time			11	20	
$t_{\text{off}}$	Turn-Off Time			23	40	
$t_f$	Fall Time			14	25	

### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

$I_s$	Drain-Source Diode Forward Current	(Note 1)			-15	A
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$I_s = -7.5 \text{ A}, V_{\text{GS}} = 0 \text{ V}$ (Note 2)			-1.3	V